

# 2SK2978

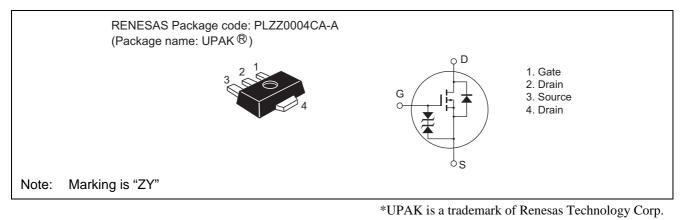
Silicon N Channel MOS FET High Speed Power Switching

> REJ03G1060-0500 (Previous: ADE-208-659C) Rev.5.00 Sep.07,2005

## Features

- Low on-resistance  $R_{DS(on)} = 0.09 \ \Omega \ typ. \ (V_{GS} = 4 \ V, \ I_D = 1.5 \ A)$
- Low drive current
- High speed switching
- 2.5 V gate drive devices.

### Outline





# **Absolute Maximum Ratings**

			$(Ta = 25^{\circ}C)$
Item	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DSS</sub>	20	V
Gate to source voltage	V <sub>GSS</sub>	±10	V
Drain current	ID	2.5	А
Drain peak current	Note1	5	А
Body-drain diode reverse drain current	I <sub>DR</sub>	2.5	А
Channel dissipation	Pch <sup>Note2</sup>	1	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW  $\leq$  10 $\mu s,$  duty cycle  $\leq$  1 %

2. When using the alumina ceramic board (12.5 x 20 x 0.7 mm)

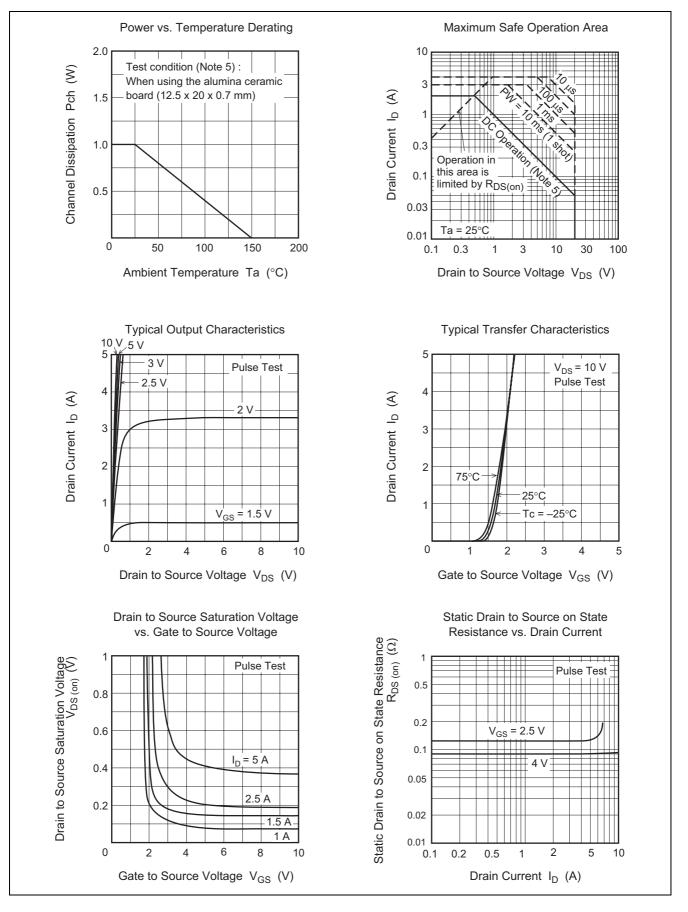
# **Electrical Characteristics**

						(Ta = 25°C)
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V <sub>(BR)DSS</sub>	20	—		V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V <sub>(BR)GSS</sub>	±10	—	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Zero gate voltage drain current	I <sub>DSS</sub>	_	—	10	μΑ	$V_{DS} = 20 V, V_{GS} = 0$
Gate to source leak current	I <sub>GSS</sub>		_	±10	μA	$V_{GS} = \pm 8 \text{ V},  V_{DS} = 0$
Gate to source cutoff voltage	V <sub>GS(off)</sub>	0.5	_	1.5	V	I <sub>D</sub> = 1 mA, V <sub>DS</sub> = 10 V
Static drain to source on state resistance	R <sub>DS(on)</sub>	_	0.09	0.12	Ω	$I_D = 1.5 \text{ A}, V_{GS} = 4 \text{ V}^{\text{Note3}}$
Static drain to source on state resistance	R <sub>DS(on)</sub>	_	0.12	0.20	Ω	$I_D$ = 1.5 A, $V_{GS}$ = 2.5 V <sup>Note3</sup>
Forward transfer admittance	y <sub>fs</sub>	3.0	5.0		S	$I_D = 1.5 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note3}}$
Input capacitance	Ciss		260		pF	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0, f = 1 MHz
Output capacitance	Coss	_	150	_	pF	
Reverse transfer capacitance	Crss	_	75	_	pF	
Turn-on delay time	t <sub>d(on)</sub>	_	15	_	ns	$V_{GS} = 4 \text{ V}, \text{ I}_{D} = 1.5 \text{ A},$
Rise time	tr	_	70	_	ns	R <sub>L</sub> = 6.67 Ω
Turn-off delay time	t <sub>d(off)</sub>	_	55	_	ns	
Fall time	t <sub>f</sub>	_	70		ns	
Body–drain diode forward voltage	V <sub>DF</sub>	_	0.9		V	$I_F = 2.5 \text{ A}, V_{GS} = 0$
Body–drain diode reverse	t <sub>rr</sub>	_	75		ns	$I_F = 2.5 \text{ A}, V_{GS} = 0$
recovery time						$di_{F}/dt = 50 \text{ A}/\mu \text{s}$

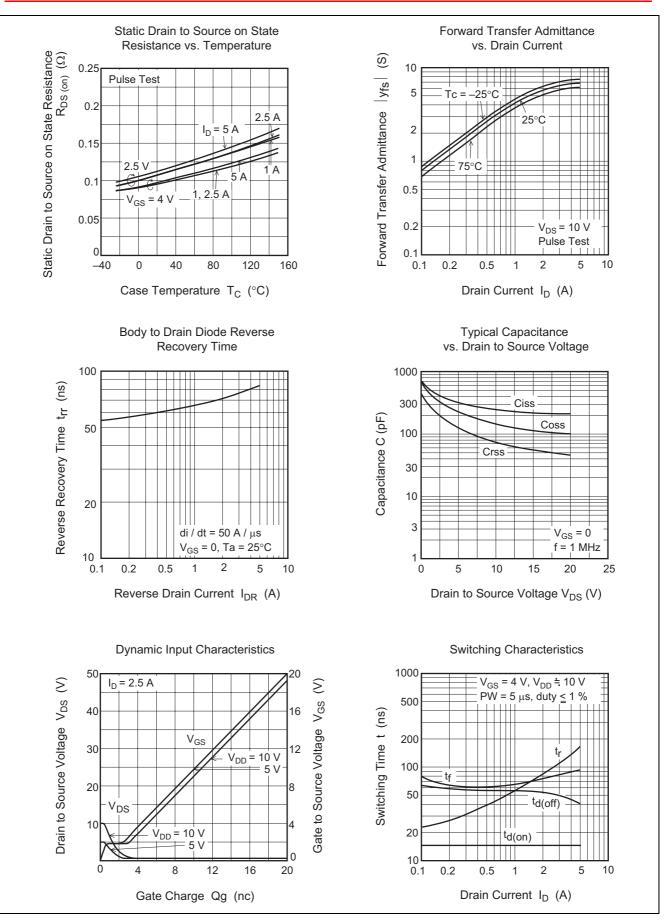
Note: 3. Pulse test



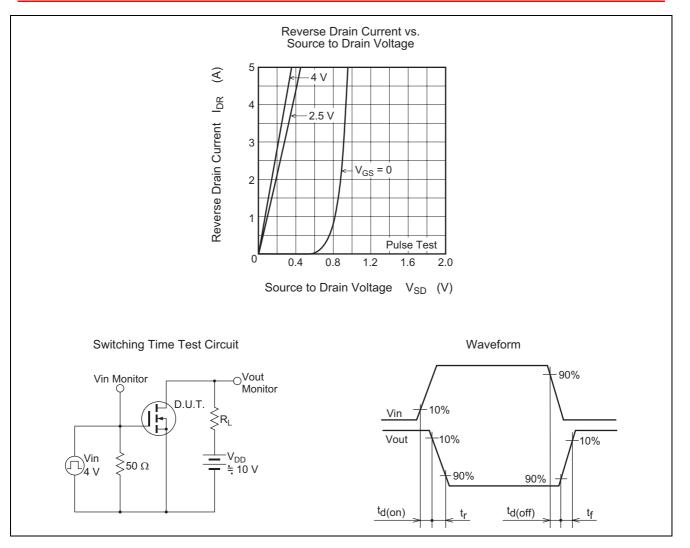
### **Main Characteristics**





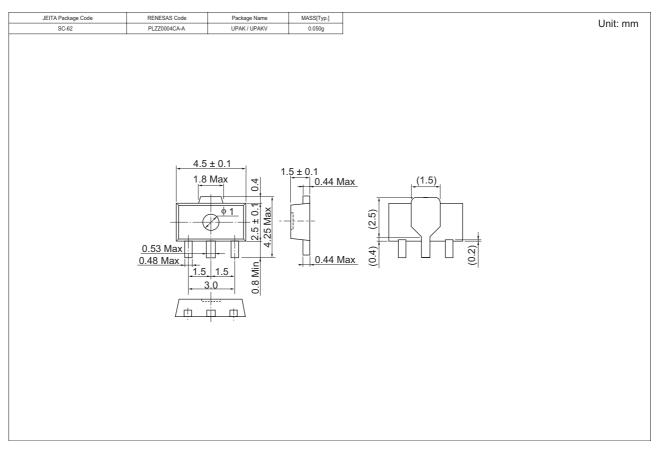








## **Package Dimensions**



### **Ordering Information**

Part Name	Quantity	Shipping Container
2SK2978ZYTL-E	1000 pcs	Taping
2SK2978ZYTR-E	1000 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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